10/826800

EAST Search History

		EAST Search				
Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	("6232150").PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:18
L2	1	("6537846").PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:53
L3	0	(reactive adj foil) and (release adj heat) and (bonding adj material) and package and device	USPAT	OR	OFF	2006/07/26 17:21
L4	0	(reactive adj foil) and (releases adj heat) and (bonding adj material) and package and device	USPAT	OR	OFF	2006/07/26 16:18
L5	0	(reactive adj foil) and heat and (bonding adj material) and package and device	USPAT	OR	OFF	2006/07/26 16:18
L6	1	1 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction and wafer or device or package)	USPAT	OR	OFF	2006/07/26 16:48
L7	1	"6063442".PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:24
L8	1	"5837562".PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:24
L9	1	"5731587".PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:25
L10	1	"5706577".PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:26
L11	1	"5668033".PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:26
L12	1	"5656512".PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:26
L13	1	12 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction and wafer or device or package)	USPAT	OR	OFF	2006/07/26 16:27
L14	1	11 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction and wafer or device or package)	USPAT	OR	OFF	2006/07/26 16:28
L15	1	10 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction and wafer or device or package)	USPAT	OR	OFF	2006/07/26 16:29

EAST Search History

L16	1	9 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction and wafer or device or package)	USPAT	OR	OFF	2006/07/26 16:29
L17	1	8 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction and wafer or device or package)	USPAT	OR	OFF	2006/07/26 16:30
L18	1	7 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction and wafer or device or package)	USPAT	OR	OFF	2006/07/26 16:32
L19	1	2 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction and wafer or device or package or heat or heating)	USPAT	OR	OFF	2006/07/26 16:59
L20	1	"6468923".PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:43
L21	1	"6426264".PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:43
L22	1	"6323417".PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:43
L23	1	"6258620".PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:44
L24	1	"6048442".PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:44
L25	. 1	"6036772".PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:44
L26	1	"5981360".PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:44
L27	1	"5627012".PN.	USPAT; USOCR	OR	OFF	2006/07/26 16:44
L29	0	(reactive adj foil adj3 heat) and (bonding adj material)	USPAT	OR	OFF	2006/07/26 16:50
L30	0	(reactive adj foil) and (bonding adj material) and heat	USPAT	OR	OFF	2006/07/26 16:50
L31	1	2 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction or wafer or device or package or heat or heating)	USPAT	OR	OFF	2006/07/26 17:09

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L32	1	25 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction or wafer or device or package or heat or heating)	USPAT	OR	OFF	2006/07/26 17:10
L33	1	27 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction or wafer or device or package or heat or heating)	USPAT	OR	OFF	2006/07/26 17:12
L34	1	26 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction or wafer or device or package or heat or heating)	USPAT	OR	OFF	2006/07/26 17:13
L35	1	20 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction or wafer or device or package or heat or heating)	USPAT	OR	OFF	2006/07/26 17:15
L36	1	21 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction or wafer or device or package or heat or heating)	USPAT	OR	OFF	2006/07/26 17:15
L37	1	22 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction or wafer or device or package or heat or heating)	USPAT	OR	OFF	2006/07/26 17:19
L38	1	23 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction or wafer or device or package or heat or heating)	USPAT	OR	OFF	2006/07/26 17:26
L39	1	24 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction or wafer or device or package or heat or heating)	USPAT	OR	OFF	2006/07/26 17:20
L40	0	(reactive adj foil) and heat and (bonding adj material) and package and device	USPAT	OR	OFF	2006/07/26 17:21

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EAST Search History

L41	0	10/461291	USPAT	OR	OFF	2006/07/26 17:22
L42	0	·				
		10/826800	USPAT	OR	OFF	2006/07/26 17:24
L43	4562	(device adj package)	USPAT	OR	OFF	2006/07/26 17:24
L44	0	43 and (bondin adj material)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/26 17:24
L45	13099	(device adj package)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/26 17:25
L46	1	10/826800	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/26 17:24
L47	301	(device adj package) and (bonding adj material)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/26 17:25
L48	3	(device adj package) and (bonding adj material) and (reactive adj foil)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/26 17:25
L49	0	48 and (reactive or bond or bonding or exothermic or foil or release or releases or material or intermetallic or mixture or perimeter or reaction or wafer or device or package or heat or heating)	USPAT	OR	OFF	2006/07/26 17:26

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